

-60V, -7.8A, 26mΩ P-channel MOSFET

JMPL0625AP

Features

- $\bullet \quad \text{Excellent $R_{\text{DS(ON)}}$ and Low Gate Charge}$
- 100% UIS Tested
- 100% ΔVds Tested
- Halogen-free; RoHS-compliant
- Pb-free plating

Applications

- Load Switch
- PWM Application
- Power Management

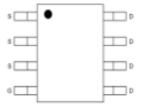
Product Summary

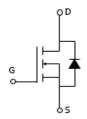
Parameters	Value	Unit
V_{DSS}	-60	٧
$V_{GS(th)_Typ}$	-1.9	٧
I _D (@V _{GS} =10V)	-7.8	Α
$R_{DS(ON)_Typ}(@V_{GS}=-10V)$	20	mΩ
$R_{DS(ON)_Typ}(@V_{GS}=-4.5V)$	26	mΩ











Pin Assignment

Schematic

Ordering Information

	Device	Marking	MSL	Form	Package	Reel(pcs)	Per Carton (pcs)
ſ	JMPL0625AP	PL0625A	3	Tape&Reel	SOP-8	4000	40000

Absolute Maximum Ratings (@ T_A = 25°C unless otherwise specified)

Symbol	Parameter		Value	Unit
V_{DS}	Drain-to-Source Voltage		-60	V
V_{GS}	Gate-to-Source Voltage		±20	V
	$T_A = 25$ °C	-7.8	A	
I _D	Continuous Drain Current	$T_A = 100$ °C	-4.9	^
I _{DM}	Pulsed Drain Current (1)		Refer to Fig.4	Α
E _{AS}	Single Pulsed Avalanche Energy (2)		165	mJ
P _D	Power Dissipation	$T_A = 25^{\circ}C$	2.1	W
L D	Fower Dissipation	$T_A = 100$ °C	0.8] vv
T_{J} , T_{STG}	Junction & Storage Temperature Range		-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient ⁽³⁾	61	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient ⁽⁴⁾	60	C/VV



Electrical Characteristics (T_J = 25°C unless otherwise specified)

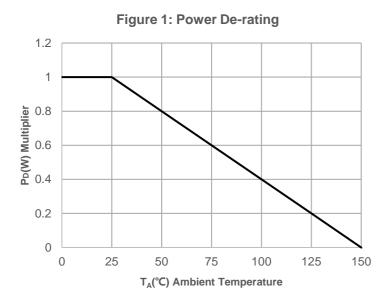
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Cha	racteristics					
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-60	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -48V, V_{GS} = 0V$	-	-	1.0	μА
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Cha	racteristics	•				
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-1.3	-1.9	-2.5	V
D	(5)	$V_{GS} = -10V, I_D = -10A$	-	20	25	mΩ
$R_{DS(ON)}$	Static Drain-Source ON-Resistance ⁽⁵⁾	$V_{GS} = -4.5V, I_{D} = -7A$	-	26	34	mΩ
Dynami	c Characteristics					
R_{g}	Gate Resistance	f = 1MHz	-	4.4	-	Ω
C _{iss}	Input Capacitance	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	1159	1623	2191	pF
C _{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = -30V,$ $f = 1MHz$	286	400	541	pF
C_{rss}	Reverse Transfer Capacitance	1 - 11/11/2	10	14	19	pF
Qg	Total Gate Charge		18	25	34	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0 \text{ to } -4.5V$ $V_{DS} = -30V, I_{D} = -7A$	-	6.5	-	nC
Q_{gd}	Gate Drain("Miller") Charge	= V _{DS} = -50 V, I _D = -7 A	-	3.3	-	nC
	ng Characteristics			l	I	I
t _{d(on)}	Turn-On DelayTime	_	-	7.5	-	ns
t _r	Turn-On Rise Time	$V_{GS} = -10V, V_{DD} = -30V$	-	4.2	-	ns
$t_{d(off)}$	Turn-Off DelayTime	$I_D = -7A$, $R_{GEN} = 3\Omega$	-	30	-	ns
t _f	Turn-Off Fall Time		-	5.7	-	ns
Body D	iode Characteristics				ı	ı
I _S	Maximum Continuous Body Diode Forward Current		-	-	-7.8	А
I_{SM}	Maximum Pulsed Body Diode Forward Cur	rent	-	-	-31	Α
V_{SD}	Body Diode Forward Voltage	$V_{GS} = 0V, I_{S} = -10A$	-		-1.2	V
trr	Body Diode Reverse Recovery Time	$I_F = -7A$, di/dt = 100A/us	-	37	-	ns
Qrr	Body Diode Reverse Recovery Charge	IF = -7 A, \(\text{u} \) \(\text{u} \) \(\text{t} \)	-	40	-	nC

Notes:

- 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
- $2.\;E_{AS}\;condition:\;Starting\;T_{J}=25C,\;V_{DD}=-30V,\;V_{G}=-10V,\;R_{G}=25ohm,\;L=3mH,\;I_{AS}=-10.5A,\;V_{DD}=0V\;during\;time\;in\;avalanche.$
- 3. $R_{\theta JA}$ is measured with the device mounted on a minimum recommended pad of 2oz copper FR4 PCB.
- 4. R_{BJA} is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB.
- 5. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.



Typical Performance Characteristics



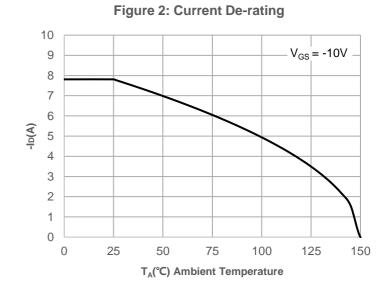


Figure 3: Normalized Maximum Transient Thermal Impedance

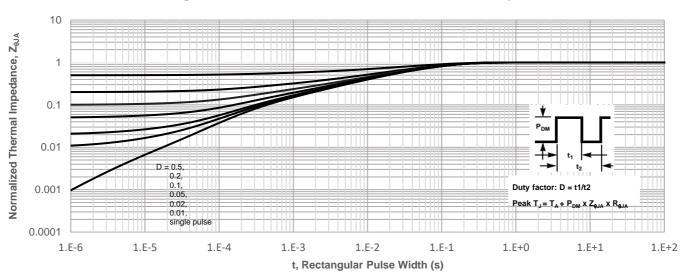
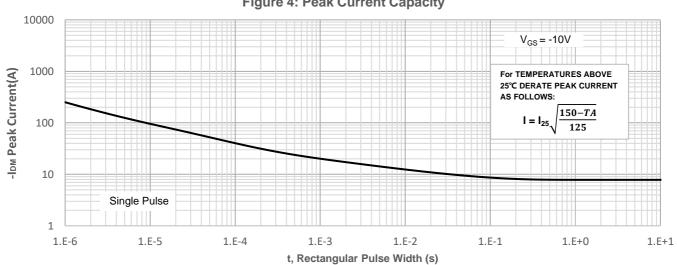


Figure 4: Peak Current Capacity





Typical Performance Characteristics

Figure 5: Output Characteristics

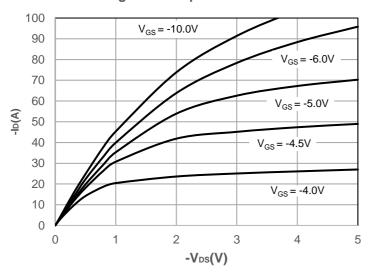


Figure 6: Typical Transfer Characteristics

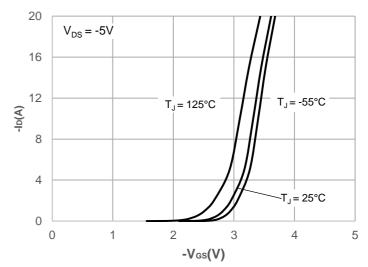


Figure 7: On-resistance vs. Drain Current

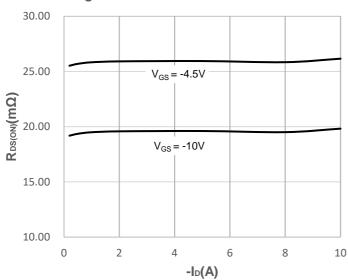


Figure 8: Body Diode Characteristics

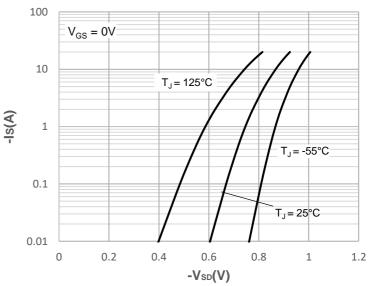


Figure 9: Gate Charge Characteristics

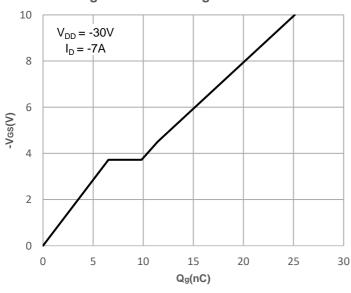
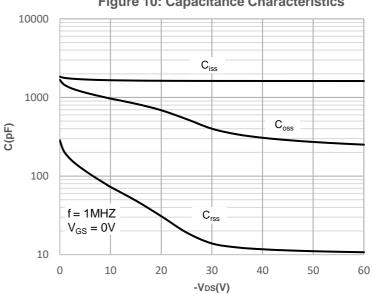


Figure 10: Capacitance Characteristics





Typical Performance Characteristics

Figure 11: Normalized Breakdown voltage vs. Junction Temperature

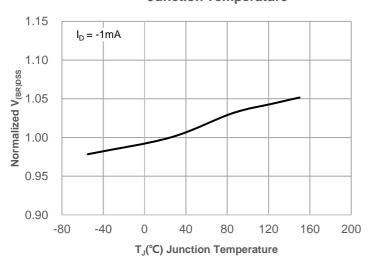


Figure 13: Normalized Threshold Voltage vs. Junction Temperature

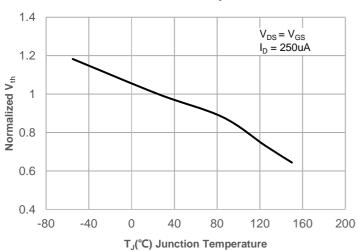


Figure 15: Maximum Safe Operating Area

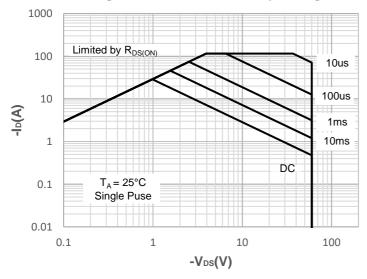
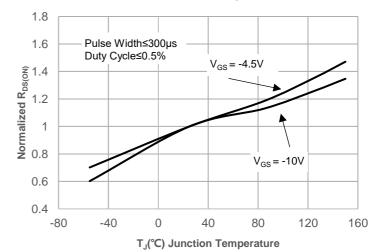
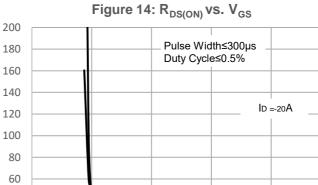


Figure 12: Normalized on Resistance vs. Junction Temperature





TJ = 150°C

T」= 25℃

12

 $-V_{GS}(V)$

16

20

 $R_{DS(ON)}(m\Omega)$

40

20

0

0



Test Circuit

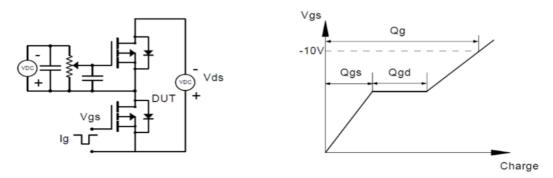


Figure 1: Gate Charge Test Circuit & Waveform

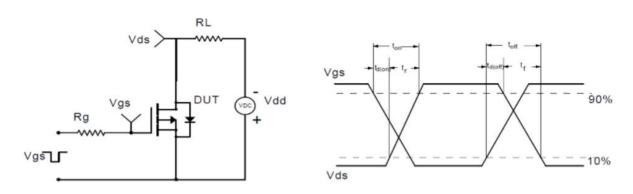


Figure 2: Resistive Switching Test Circuit & Waveform

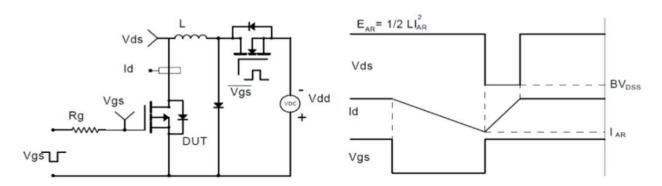


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

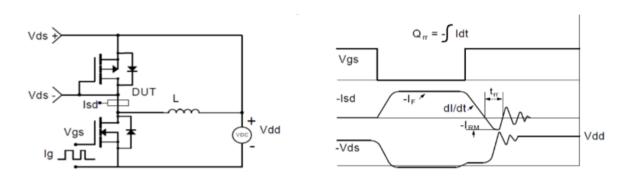


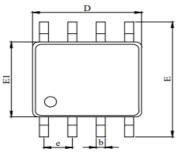
Figure 4: Diode Recovery Test Circuit & Waveform

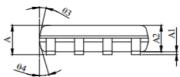
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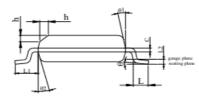


Package Mechanical Data(SOP-8)

Package Outline

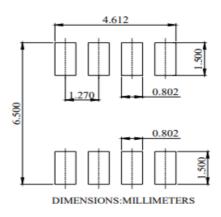






DIM		MILLIMETER		
DIM	MIN.	NOM.	MAX.	
A	1.35	1.50	1.65	
A1	0.05	0.10	0.15	
A2	1.35	1.40	1.50	
b	0.38		0.50	
c	0.17		0.25	
D	4.80	4.90	5.00	
Е	5.80	6.00	6.20	
El	3.80	3.90	4.00	
e	1.27(BSC)			
L	0.45	0.60	0.80	
Ll	1.04 REF			
L2	0.25 BSC			
h	0.30	0.40	0.50	
θ	0°		8°	
θ_1	10°	12°	14°	
θ2	8°	10°	12°	
θ3	10°	12°	14°	
θ4	8°	10°	12°	

Recommended Footprint



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